

N-channel 80 V, 3.5 mΩ standard level MOSFET in TO-220 Rev. 03 — 19 April 2011 Product data s

Product data sheet

Product profile 1.

1.1 General description

Standard level N-channel MOSFET in TO-220 package qualified to 175C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- Suitable for standard level gate drive

1.3 Applications

- DC-to-DC converters
- Load switch

- Motor control
- Server power supplies

1.4 Quick reference data

Table 1. **Quick reference data**

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	80	V
I _D	drain current	T_{mb} = 25 °C; V_{GS} = 10 V; see <u>Figure 1</u>	<u>[1]</u>	-	-	120	A
P _{tot}	total power dissipation	T _{mb} = 25 °C; see Figure 2		-	-	338	W
Т _ј	junction temperature			-55	-	175	°C
Static ch	aracteristics						
R _{DSon}	drain-source on-state resistance			-	5	5.8	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 25 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 13}{100000000000000000000000000000000000$	[2]	-	3	3.5	mΩ
Dynamic	characteristics						
Q_{GD}	gate-drain charge	V_{GS} = 10 V; I _D = 75 A;		-	27	-	nC
Q _{G(tot)}	total gate charge	$V_{DS} = 40 V$; see Figure 14; see Figure 15		-	139	-	nC
Avalanche ruggedness							
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$ \begin{split} V_{GS} &= 10 \text{ V}; \text{T}_{j(\text{init})} = 25 ^\circ\text{C}; \\ I_D &= 120 \text{A}; V_{sup} \leq 80 \text{V}; \\ \text{R}_{GS} &= 50 \Omega; \text{ unclamped} \end{split} $		-	-	676	mJ



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- [1] Continuous current is limited by package.
- [2] Measured 3 mm from package.

2. Pinning information

Table 2.	Pinning	j information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	
3	S	source		
mb	D	drain		mbb076 S

SOT78 (TO-220AB)

3. Ordering information

Table 3. Ordering information				
Type number	Package			
	Name	Description	Version	
PSMN3R5-80PS	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78	

PSMN3R5-80PS Product data sheet

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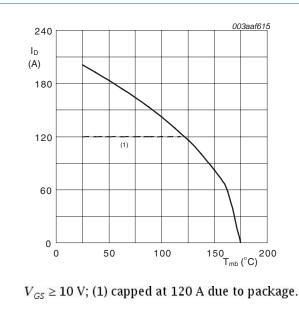
4. Limiting values

Table 4. Limiting values

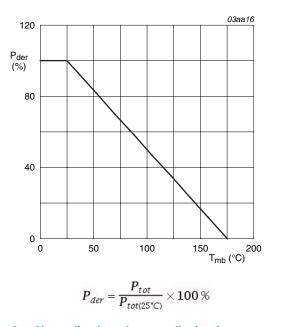
In accordance with the Absolute Maximum Rating System (IEC 60134).

		5, (
Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	80	V
V _{DGR}	drain-gate voltage	T _j ≥ 25 °C; T _j ≤ 175 °C; R _{GS} = 20 kΩ		-	80	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 100 °C; see <u>Figure 1</u>	[1]	-	120	А
		V_{GS} = 10 V; T_{mb} = 25 °C; see <u>Figure 1</u>	[1]	-	120	А
I _{DM}	peak drain current	pulsed; t _p ≤ 10 µs; T _{mb} = 25 °C; see <u>Figure 3</u>		-	803	A
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	338	W
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-drai	in diode					
I _S	source current	T _{mb} = 25 °C	<u>[1]</u>	-	120	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		-	803	А
Avalanche r	ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$ \begin{array}{l} V_{GS} = 10 \; V; \; T_{j(\text{init})} = 25 \; ^\circ \! C; \; I_{D} = 120 \; A; \\ V_{sup} \leq 80 \; V; \; R_{GS} = 50 \; \Omega; \; \text{unclamped} \end{array} $		-	676	mJ

[1] Continuous current is limited by package.



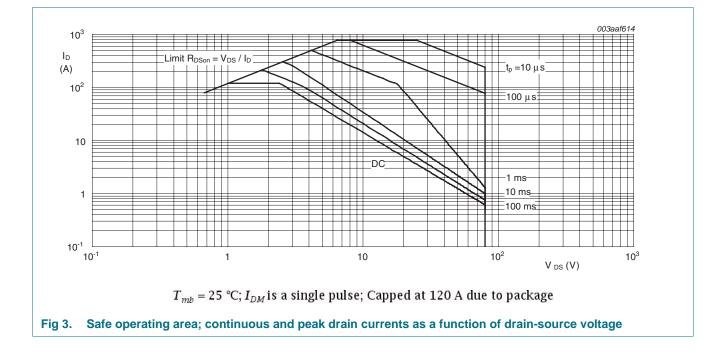






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5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 4	-	0.22	0.44	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	Vertical in free air	-	60	-	K/W

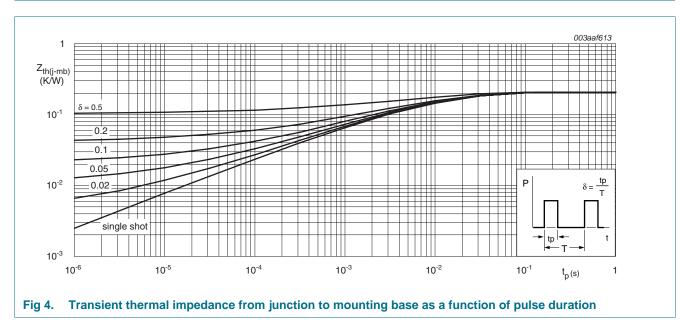


Table 5. Thermal characteristics

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6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V _{(BR)DSS}	drain-source breakdown	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ C$	73	-	-	V
	voltage	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$	80	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see <u>Figure 10</u>	1	-	-	V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _j = -55 °C; see <u>Figure 10</u>	-	-	4.6	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 10</u> ; see <u>Figure 11</u>	2	3	4	V
I _{DSS}	drain leakage current	V_{DS} = 80 V; V_{GS} = 0 V; T_j = 25 $^\circ C$	-	0.02	10	μA
		$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 \text{ °C}$	-	-	500	μΑ
I _{GSS}	gate leakage current	V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
		$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{V}; \text{T}_{j} = 25 ^{\circ}\text{C}$	-	-	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; see <u>Figure 12</u>	-	7.2	8.4	mΩ
	V_{GS} = 10 V; I_D = 25 A; T_j = 100 °C; see Figure 12	-	5	5.8	mΩ	
		V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; see <u>Figure 13</u>	[1] -	3	3.5	mΩ
R _G	internal gate resistance (AC)	f = 1 MHz	-	0.9	-	Ω
Dynamic	characteristics					
Q _{G(tot)}	total gate charge	$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}$	-	135	-	nC
		$I_D = 75 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$	-	139	-	nC
Q_{GS}	gate-source charge	see Figure 14; see Figure 15	-	51	-	nC
Q _{GS(th)}	pre-threshold gate-source charge		-	30	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge		-	21	-	nC
Q _{GD}	gate-drain charge		-	27	-	nC
V _{GS(pl)}	gate-source plateau voltage	$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; \text{see } Figure 14;$ see Figure 15	-	5.8	-	V
C _{iss}	input capacitance	$V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$	-	9961	-	pF
C _{oss}	output capacitance	T _j = 25 °C; see <u>Figure 16</u>	-	847	-	pF
C _{rss}	reverse transfer capacitance		-	401	-	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 40 \text{ V}; \text{R}_{L} = 0.53 \Omega; \text{V}_{GS} = 10 \text{ V};$	-	41	-	ns
t _r	rise time	$R_{G(ext)} = 10 \ \Omega; \ I_D = 75 \ A$	-	43	-	ns
t _{d(off)}	turn-off delay time		-	109	-	ns
t _f	fall time		-	44	-	ns

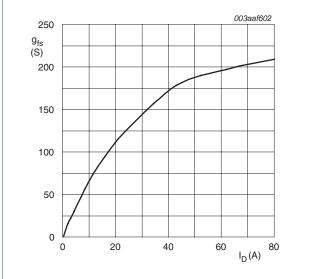
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	Table 6.	Characteristics	continued
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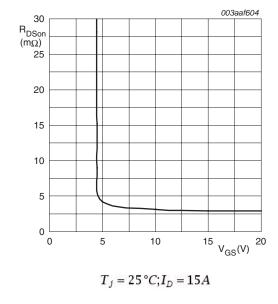
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-dra	ain diode					
V _{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; see <u>Figure 17</u>	-	0.8	1.2	V
t _{rr}	reverse recovery time	$I_{S} = 25 \text{ A}; \text{ d}I_{S}/\text{d}t = 100 \text{ A}/\mu\text{s};$	-	63	-	ns
Qr	recovered charge	$V_{GS} = 0 V; V_{DS} = 20 V$	-	121	-	nC

[1] Measured 3 mm from package.

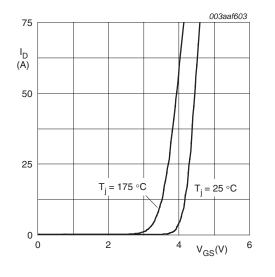


 $T_j = 25 \,^{\circ}C; V_{DS} = 25V$



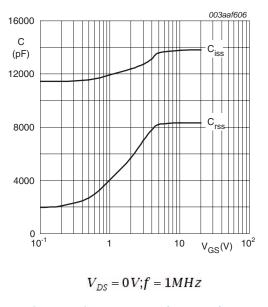












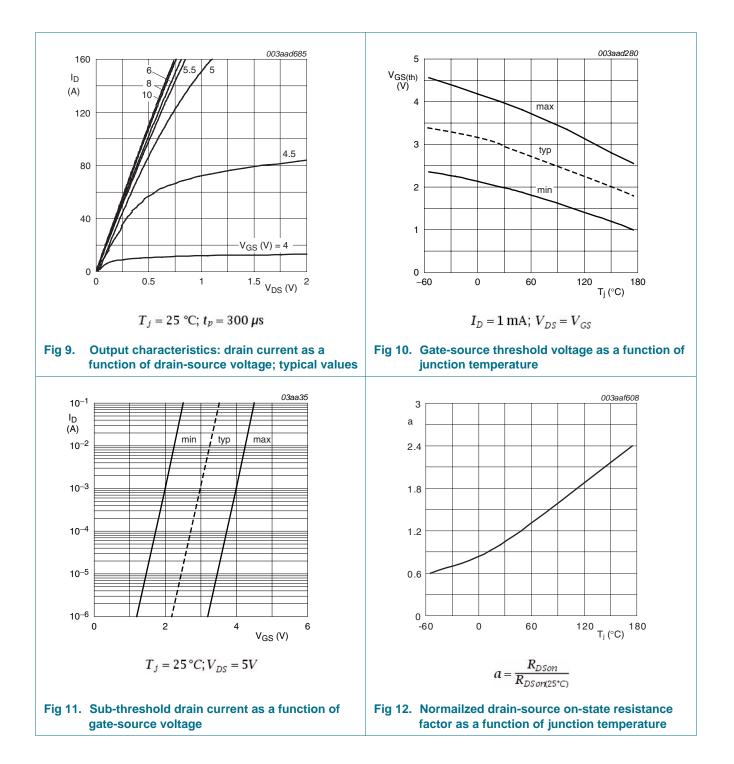


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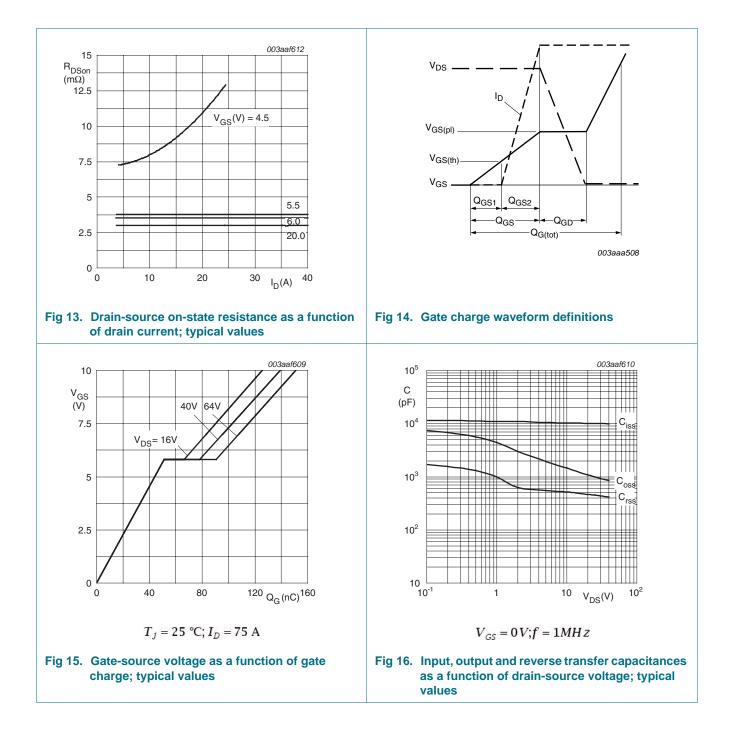
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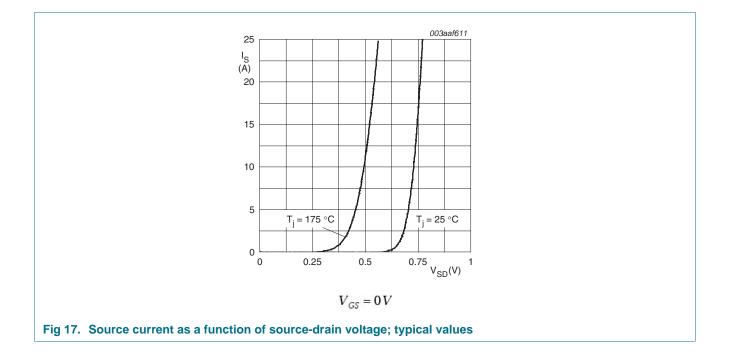
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Package outline 7.

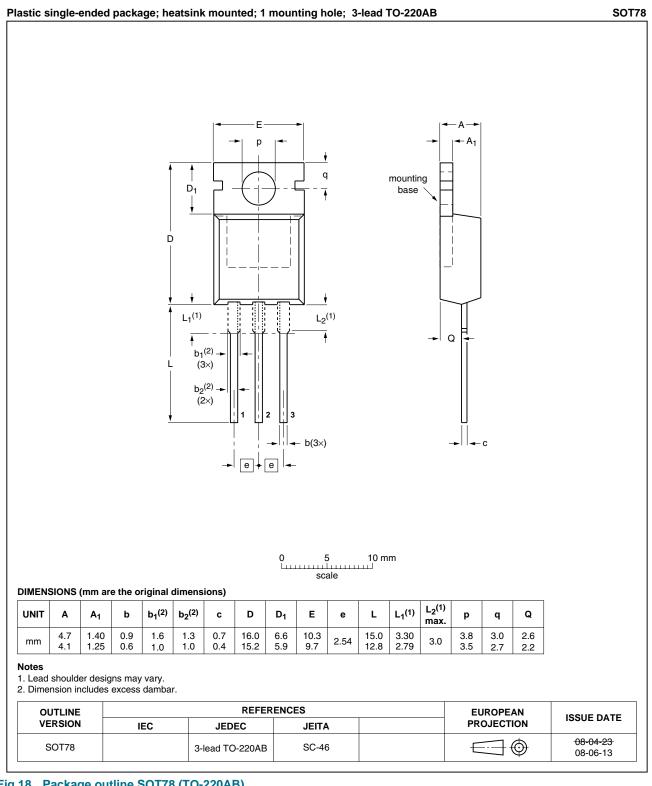


Fig 18. Package outline SOT78 (TO-220AB)

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8. Revision history

Table 7.Revision h	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN3R5-80PS v.3	20110419	Product data sheet	-	PSMN3R5-80PS v.2
Modifications:	 Status change 	d from objective to product.		
 Various changes to content. 				
PSMN3R5-80PS v.2	20110304	Objective data sheet	-	PSMN3R5-80PS v.1

9. Legal information

9.1 Data sheet status

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Date of release: 19 April 2011 Document identifier: PSMN3R5-80PS